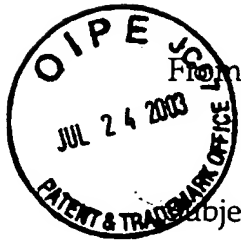


Docket: CS 99 - 060  
S/N: 09/518,204

AF/1700

To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231

From: George O. Saile, Reg. No. 19,572  
28 Lewis Avenue  
Poughkeepsie, N.Y. 12603



Subject:

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Serial No.: 09/518,204	Filed: 03/03/00
Inventor: Keung Ho	
Title: Chemical Agent Additives in Copper CMP Slurry	
Group Art Unit: 1746	Examiner: Carrillo, B. S.
Attorney Docket: CS 99 - 060	

**RESPONSE TO PATENT OFFICE ACTION**

Dear Sir:

In response to the Final office action dated 05/29/03, please consider the following remarks:

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450, on July 22, 2003.

Signature/Date

7/22/03

Stephen B. Ackerman

Reg. No. 37,761

OK to  
enter  
box  
8/18/03